



# Material Composition Declaration

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

Adobe Reader version 7.0.5 is required to complete this declaration.

1752-2 1.1	IPC Web Site for Information on IPC-1752 Standard <a href="http://www.ipc.org/IPC-175x">http://www.ipc.org/IPC-175x</a>	Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat
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## Supplier Information

<b>Company Name *</b> Mindspeed Technologies Inc	Company Unique ID N/A	Unique ID Authority N/A	<b>Response Date *</b> 2012-09-10	Response Document ID				
<b>Contact Name *</b> Cynthia Ong	Title - Contact Program Manager	<b>Phone - Contact *</b> 949-579-5515	<b>Email - Contact *</b> cynthia.ong@mindspeed.com					
<b>Authorized Representative *</b> Amy Teng	Title - Representative Quality Engineer	<b>Phone - Representative *</b> 604-6328114	<b>Email - Representative *</b> amy.teng@mindspeed.com	Supplier Comments or URL for Additional Information				
Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufacturing Site	Weight *	UOM	Unit Type
M02050G-15	M02050G-15	3QFN 16	2010-10-26	D	Amkor, Korea	21.929	mg	EACH
Alternate Recommendation		NA		Alternate Item Comments	NA			

## Manufacturing Process Information

Terminal Plating / Grid Array Material	Terminal Base Alloy	J-STD-020 MSL Rating	Peak Process Body Temperature	Max Time at Peak Temperature	Number of Reflow Cycles
Tin	Cu Alloy	2	260 C	40 seconds	3
Comments N/A					

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Import Data

Locked

## RoHS Material Composition Declaration

Declaration Type \*

Simplified

**RoHS Directive 2002/95/EC** **RoHS Definition:** Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium

Supplier certifies that it gathered the information it provides in this form concerning RoHS restrictive substances using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.

**RoHS Declaration \*** 1 - Item(s) does not contain RoHS restricted substances per the definition above

**Supplier Acceptance \*** Accepted

**Exemptions:** If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.

## Declaration Signature

**Instructions:** Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## Homogeneous Material Composition Declaration for Electronic Products

**SubItem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

**Substance Instructions:** [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

**Line Functions:** +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

Item/SubItem Name	Homogeneous Material	Weight	Unit of Measure	Level	Substance Category	Substance	CAS	Exempt	Weight	Unit of Measure	Tolerance		PPM
											-	+	
M02050G-15	Die	1.51	mg	C	GROUP-C	Silicon Die	7440-21-3		1.51	mg			999,99
	Leadfinish	0.36	mg	C	GROUP-C	Tin	7440-31-5		0.36	mg			999,99
	Die Attach	0.6	mg	C	GROUP-C	Bisphenol F type liquid	9003-36-5		0.024	mg			39,999
				C	GROUP-C	gamma-Butyrolactone	96-48-0		0.024	mg			39,999
				C	GROUP-C	2,6-diglycidyl phenyl alk	417-470-1		0.024	mg			39,999
				C	GROUP-C	Silver	7440-22-4		0.462	mg			769,99
				C	GROUP-C	Poly[oxy(methyl- 1,2-eth	9046-10-0		0.024	mg			39,999
				C	GROUP-C	Epoxy Resin A	Proprietary		0.042	mg			69,999
	Leadframe	12.322	mg	C	GROUP-C	Copper	7440-50-8		12.005	mg			974,27
				C	GROUP-C	Iron	7439-89-6		0.29	mg			23,535
				C	GROUP-C	Phosphorous	7723-14-0		0.011	mg			892.71
				C	GROUP-C	Zinc	7440-66-6		0.016	mg			1,298.4
	Gold Wire	0.18	mg	C	GROUP-C	Gold	7440-57-5		0.18	mg			999,99
	Mold compound	6.667	mg	C	GROUP-C	Phenol Resin	Proprietary		0.433	mg			64,946
				C	GROUP-C	Epoxy resins	Proprietary		0.6	mg			89,995
				C	GROUP-C	Bismuth compounds	Proprietary		0.007	mg			1,049.9
				C	GROUP-C	Silica, Vitreous	60676-86-0		5.6	mg			839,95
				C	GROUP-C	Carbon black	1333-86-4		0.027	mg			4,049.7
	Leadframe Platin	0.29	mg	C	GROUP-C	Silver	7440-22-4		0.29	mg			999,99